



JAE Electronics, Inc.
February 3rd, 2018

ENG-E18-020 - Distributors

PCN (Process Change Notice) MX50019NQ1 Replacement Mold Die (PF,PG,PH,PJ) To Keep Production Capacity

Part Number	2 Existing Mold Dies with 4 cavities	1 Replacement Mold Die with 4 cavities	Replacement Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX50019NQ1	(PB,PC), (PD,PE),	(PF,PG,PH,PJ) To replace (PB,PC)	April 2018	June 2018	July 2018 (after all PPAP approved From all Customers)

Notes:

- PC = Process Change (in Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
 - PPAP = Production Part Approval Process
1. PC PPAP will only be prepared and provided to customer who already requested and received Initial PPAP before.
 2. If you need PC PPAP documents, please notify us no later than **2/12/18** in order for factory to prepare and submit by the proposed time.